

MBR30L150CT, MBR30L150FCT
SCHOTTKY BARRIER RECTIFIERS



VOLTAGE: 150 Volts

CURRENT: 30.0 Amperes

Marking and Polarity

FEATURES

- Low forward voltage drop for high efficiency
- Low power loss for high reliability
- High forward surge capability for high reliability
- High frequency operation
- Solder bath temperature 260°C maximum, 10s, per JESD22-B106
- Component in accordance to RoHS 2011/65/EU

MECHANICAL DATA

- Terminals:** Plated Leads Solderable per MIL-STD-202, Method 208
- Mounting Position:** Any
- Lead Free:** Lead Free Finish, RoHS Compliant
- Polarity:** As marked

TYPICAL APPLICATIONS

- For use in high frequency inverters, Switch power supply
AC/DC converters, LED driver etc. applications

TO-220AB

MBR30L150CT



TO-220F

MBR30L150FCT



Remark:

- NH=niuhang trademark;
- FF=Product line code, According to actual changes
YWW=Data code, According to actual changes
EDDQK=Internal code, According to actual changes
- MBR30L150CT/FCT=Module.

Maximum Ratings (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	MBR30L150CT, MBR30L150FCT	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	150	V
Maximum average forward rectified current (see fig.1)	$I_{F(AV)}$	30	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)	I_{FSM}	250	A
Peak repetitive reverse current per diode at $t_p=2\mu s$ 1KHz	I_{RRM}	10	μA
Isolation voltage (TO-220F only) from terminals to heatsink $t=1$ min	V_{AC}	1500	V

Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Test Conditions	Symbol	MBR30L150CT, MBR30L150FCT			Unit
			Min.	Typ.	Max.	
Instantaneous forward voltage per diode (note1)	$T_A=25^\circ C$	$I_F=15 A$	--	0.85	0.90	V
	$T_A=125^\circ C$		--	0.77	0.85	
Reverse current per diode (note1)	$T_A=25^\circ C$	$V_R=V_{RRM}$	--	1	10	μA
	$T_A=125^\circ C$	$V_R=80\% \cdot V_{RRM}$	--	0.5	5	mA
Typical junction capacitance	4V, 1MHz	C_J	--	750	--	pF

Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	MBR30L150CT, MBR30L150FCT	Unit
Operating junction	T_J	-55 to 175	$^\circ C$
Storage temperature range	T_{STD}	-55 to 175	
Typical thermal resistance (note2)	$R_{\theta JC}$	TO-220AB	$^\circ C/W$
		2.5	
		TO-220F	
		4.5	

- Notes:
- Pulse test: 300 μs pulse width, 1% duty cycle
 - Device mounted on Device mounted on 75mm x 45mm x 2.5mm Aluminum Plate Heatsink.

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RATING AND CHARACTERISTIC CURVES

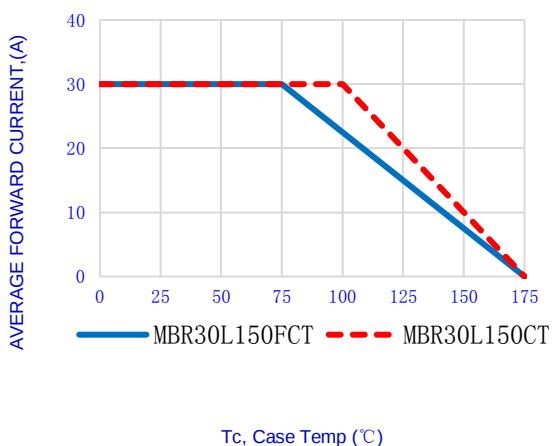


Fig.1-FORWARD CURRENT DERATING CURVE

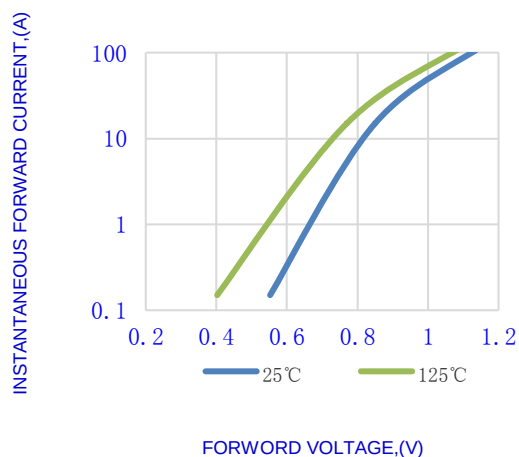


Fig.2- TYPICAL INSTANTANEOUS FORWARD

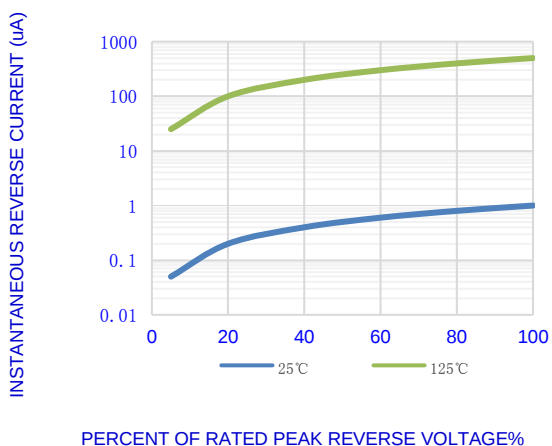


Fig.3- TYPICAL REVERSE CHARACTERISTICS

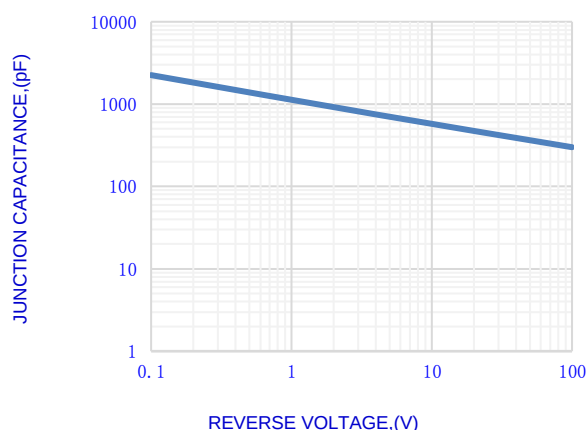


Fig.4- TYPICAL JUNCTION CAPACITANCE

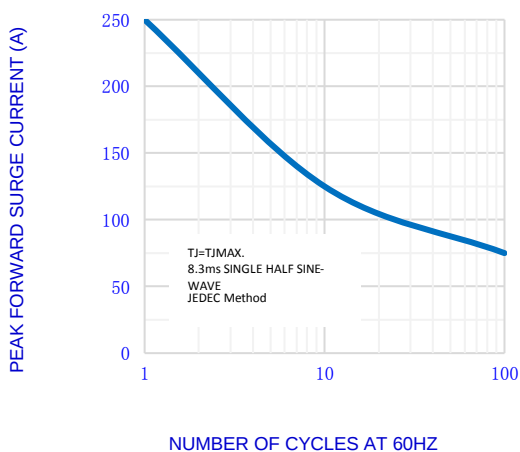


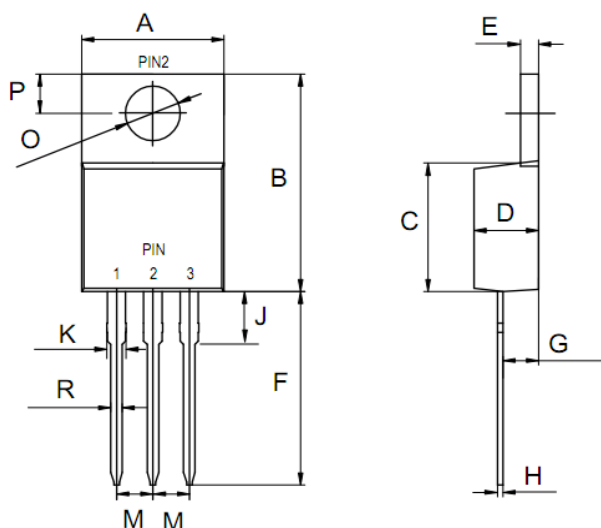
Fig.5-MAX. NON-REPETITIVE SURGE CURRENT

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OUTLINE DRAWINGS

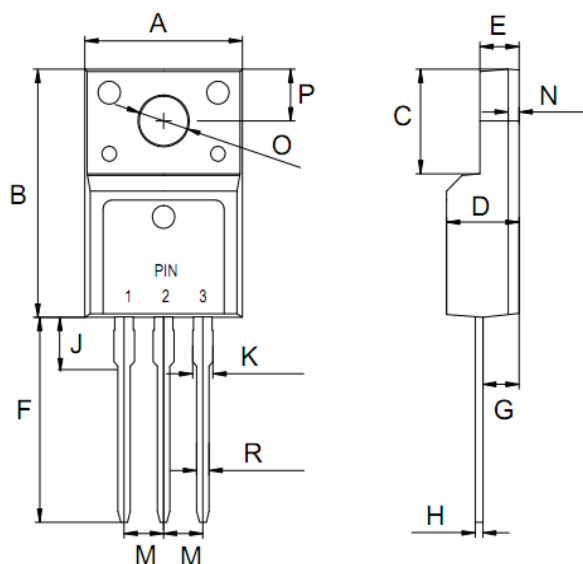
TO-220AB



OUTLINE DIMENSIONS						
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	9.80	-	10.40	0.3858	-	0.4094
B	14.95	-	15.50	0.5886	-	0.6102
C	8.40	-	9.40	0.3307	-	0.3701
D	4.20	-	4.70	0.1654	-	0.1850
E	1.15	-	1.45	0.0453	-	0.0571
F	12.50	-	-	0.4921	-	-
G	2.30	-	2.70	0.0906	-	0.1063
H	0.30	-	0.45	0.0118	-	0.0177
J	3.00	-	4.50	0.1181	-	0.1772
M	2.44	-	2.64	0.0961	-	0.1039
R	0.70	-	1.00	0.0276	-	0.0394
O	3.45	-	3.85	0.1358	-	0.1516
P	2.80	-	3.20	0.1102	-	0.1260

OUTLINE DRAWINGS

TO-220F



OUTLINE DIMENSIONS						
Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	9.91	10.21	10.41	0.3902	0.4020	0.4098
B	15.30	16.00	16.50	0.6024	0.6299	0.6496
C	6.20	6.75	7.20	0.2441	0.2657	0.2835
D	4.44	4.70	4.80	0.1748	0.1850	0.1890
E	2.45	2.57	3.55	0.0965	0.1012	0.1398
F	12.50	13.50	14.50	0.4921	0.5315	0.5709
G	2.25	2.40	2.60	0.0886	0.0945	0.1024
H	0.35	0.50	0.58	0.0138	0.0197	0.0228
J	2.60	2.88	4.00	0.1024	0.1134	0.1575
M	2.41	2.50	2.67	0.0949	0.0984	0.1051
N	4.88	5.00	5.28	0.1921	0.1969	0.2079
R	0.58	0.82	0.94	0.0228	0.0323	0.0370
O	3.25	3.55	3.75	0.1280	0.1398	0.1476
P	2.15	3.30	3.50	0.0846	0.1299	0.1378

PACKING INFORMATION

Package Code	Package Method	Tube Size L×W×H(mm)	Quantity (pcs/Tube)	Inner Box Size L×W×H(mm)	Quantity (pcs/Inner Box)	Outer Carton Size L×W×H(mm)	Quantity (pcs/carton)
TO-220AB	Tube	530x35x8	50	560x155x55	1000	570×284×185	5000
TO-220F	Tube	530x35x8	50	560x155x55	1000	570×284×185	5000

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

The graph illustrates a heat treatment cycle with the following parameters and phases:

- Temperature Axis:** Markers include 25, $T_{s_{min}}$, $T_{s_{max}}$, T_L , and T_p .
- Time Axis:** Markers include t (25°C to Peak), t_s (Preheat), t_p (Ramp-up), and t_L (Critical Zone).
- Phases:**
 - Preheat:** A horizontal segment at T_L with duration t_s .
 - Ramp-up:** A linear increase from T_L to T_p with duration t_p .
 - Critical Zone:** A horizontal segment at T_p with duration t_L .
 - Ramp-down:** A linear decrease from T_p to T_L .
- Shaded Regions:** The area under the temperature-time curve is shaded light blue, representing the total heat input.

Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmax to Tp)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(TS min) -Temperature Max(TS max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (TL) - Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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